

C 10/21/02

10-31-2002



Form PTO-1595

(Rev. 03/01)

OMB No. 0651-0027 (exp. 5/31/2002)

R

102267643

U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

1. Name of conveying party(ies):

a) Minoru Hashimoto and b) Toyoshi Okada

Additional name(s) of conveying party(ies)
attached?☐ Yes☒ No

3. Nature of Conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☒ Other Corrected; Reel/Frame: 013020/0704

Execution Date: a) May 1, 2002, b) May 12, 2002

2. Name and address of receiving party(ies)

Name: Sony Computer Entertainment Inc.

Internal Address:

Street Address:

1-1, Akasaka 7-chome
Minato-ku

City: Tokyo

State: Japan

Zip: 107-0052

Additional name(s) &
address(es) attached:☐ Yes☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the new application is:

A. Patent Application No.(s):

10/079,708

B. Patent No.(s):

Additional numbers attached?

☐ Yes☒ No5. Name and address of party to whom correspondence
concerning document should be mailed:Name: Robert B. Cohen
LERNER, DAVID, LITTENBERG, KRUMHOLZ &
MENTLIK, LLP

Internal Address:

Street Address: 600 South Avenue West

City:

Westfield

State:

NJ

Zip:

07090

6. Total number of applications and
patents involved:

7. Total fee (37 CFR 3.41)

\$ 40.00

☐ Enclosed☒ Authorized to be charged to deposit account☐ Authorized to be charged to credit card
(Form 2038 enclosed)

8. Deposit account number:

12-1095

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Robert B. Cohen
Name of Person Signing

Signature

October 15, 2002
Date

Total number of pages including cover sheet, attachments, and documents: 7

10/30/2002 TBIAZ1 00000060 121095 10079708
01 FC:8021 40.00 CH

394433

PATENT
REEL: 013425 FRAME: 0355

Form PTO-1595
(Rev. 03/01)

OMB No. 0651-0027 (exp. 5/31/2002)

RECORDATION FORM COVER SHEET
PATENTS ONLY

U.S. Patent and Trademark Office
DEPT. OF COMMERCE

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

1. Name of conveying party(ies):

Minoru Hashimoto and Toyoshi Okada

Additional name(s) of conveying party(ies) attached?

☐ Yes

☒ No

3. Nature of Conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: May 12, 2002

2. Name and address of receiving party(ies)

Name: Sony Computer Entertainment Inc.

Internal Address:

Street Address:

1-1, Akasaka 7-chome
Minato-ku

City: Tokyo

State: Japan

Zip: 107-0052

Additional name(s) &
address(es) attached:

☐ Yes

☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the new application is:

A. Patent Application No.(s):

10/079,708

B. Patent No.(s):

Additional numbers attached?

☐ Yes

☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: LERNER, DAVID, LITTENBERG, KRUMHOLZ &
MENTLIK, LLP

Street Address: 600 South Avenue West

City:

Westfield

State:

NJ

Zip:

07090

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41)

\$ 40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

8. Deposit account number:

12-1095

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert B. Cohen

Name of Person Signing

Signature

June 5, 2002

Date

Total number of pages including cover sheet, attachments, and documents: 3

371834 L.DOC

06/26/2002 LMIELLER 00000175 121095 10079708

01 FC:581

40.00 CH

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

COMMUNICATION SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo 107-0052, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 10/079,708, Filing Date: February 20, 2002.

This assignment executed on the dates indicated below.

Minoru HASHIMOTO

Name of First or Sole Inventor

Execution Date of U.S. Patent Application

Tokyo, Japan

Residence of First or Sole Inventor

M. Hashimoto

Signature of First or Sole Inventor

May 1, 2002

Date of this Assignment

Toyoshi OKADA

Name of Second Joint Inventor

Execution Date of U.S. Patent Application

Tokyo, Japan

Residence of Second Joint Inventor

Toyoshi Okada

May 12, 2002

Signature of Second Joint Inventor

Date of this Assignment

Name of Third Joint Inventor

Execution Date of U.S. Patent Application

Residence of Third Joint Inventor

Signature of Third Joint Inventor

Date of this Assignment

Name of Fourth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fourth Joint Inventor

Signature of Fourth Joint Inventor

Date of this Assignment

Name of Fifth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fifth Joint Inventor

Signature of Fifth Joint Inventor

Date of this Assignment

361500_1.DOC

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

COMMUNICATION SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo 107-0052, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 10/079,708, Filing Date: February 20, 2002.

This assignment executed on the dates indicated below.

Minoru HASHIMOTO
Name of First or Sole Inventor

Execution Date of U.S. Patent Application

Tokyo, Japan
Residence of First or Sole Inventor

M Hashimoto
Signature of First or Sole Inventor

May 1, 2002
Date of this Assignment

Toyoshi OKADA

Name of Second Joint Inventor

Execution Date of U.S. Patent Application

Tokyo, Japan

Residence of Second Joint Inventor

Toyoshi Okada

May 12, 2002

Signature of Second Joint Inventor

Date of this Assignment

Name of Third Joint Inventor

Execution Date of U.S. Patent Application

Residence of Third Joint Inventor

Signature of Third Joint Inventor

Date of this Assignment

Name of Fourth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fourth Joint Inventor

Signature of Fourth Joint Inventor

Date of this Assignment

Name of Fifth Joint Inventor

Execution Date of U.S. Patent Application

Residence of Fifth Joint Inventor

Signature of Fifth Joint Inventor

Date of this Assignment

361500_1.DOC